

# STMP3770XXLAE3N

(Not Recommended for New Designs)

Piano 2p0 TA3 ROM Revision



Package :  
LQFP100

LQFP100, plastic, low profile quad flat package; 100 terminals; 0.5 mm pitch; 14 mm x 14 mm x 1.4 mm body

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## Environmental Information

Material Declaration	PbFree	EU RoHS	Halogen Free	RHF Indicator	2nd Level Interconnect	REACH SVHC	Weight (mg)
<a href="#">STMP3770XXLAE3N</a> ( 935323032557 )	Yes	Yes Certificate Of Analysis (CoA)	Yes	D	e3	<a href="#">REACH SVHC</a>	650.4

## Quality Information

Material Declaration	Safe Assure Functional Safety	Moisture Sensitivity Level (MSL)	Peak Package Body Temperature (PPT) (C°)	Maximum Time at Peak Temperatures (s)
		Lead Free Soldering	Lead Free Soldering	Lead Free Soldering
<a href="#">STMP3770XXLAE3N</a> ( 935323032557 )	No	3	260	40

## Shipping Information

Part Number	Harmonized Tariff (US) <a href="#">Disclaimer</a>	Export Control Classification Number (US)
<a href="#">STMP3770XXLAE3N</a> ( 935323032557 )	854231	5A992

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